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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/683,838 10/09/2003		Jackson Hsieh	2011129	2725	
7590 10/19/2004			EXAMINER		
PRO-TECHTOR INTERNATIONAL 20775 Norada Court			TRAIL, ALLYSON NEEL		
Saratoga, CA			ART UNIT	PAPER NUMBER	
			2876		

DATE MAILED: 10/19/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary		Applica	pplication No. Applicant(s)				
		10/683,	838	HSIEH ET AL.	HSIEH ET AL.		
		Examin	er	Art Unit			
		Allyson I		2876	b~		
T	he MAILING DATE of this communicat eply	ion appears on ti	he cover sheet wi	th the correspondence ad	dress		
THE MAI - Extension after SIX (- If the period - If NO period - Failure to Any reply	TENED STATUTORY PERIOD FOR ILING DATE OF THIS COMMUNICA's of time may be available under the provisions of 37 (6) MONTHS from the mailing date of this communicate of reply specified above is less than thirty (30) day od for reply is specified above, the maximum statutor reply within the set or extended period for reply will, by received by the Office later than three months after that term adjustment. See 37 CFR 1.704(b).	TION. CFR 1.136(a). In no ention. ys, a reply within the st y period will apply and by statute, cause the ap	event, however, may a reattory minimum of thirt will expire SIX (6) MON opplication to become AB	eply be timely filed by (30) days will be considered timely THS from the mailing date of this co ANDONED (35 U.S.C. § 133).	v. mmunication.		
Status							
1) <u></u> Re	sponsive to communication(s) filed or	າ					
2a)∏ Thi	is action is FINAL . 2b)[☐ This action is	non-final.				
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposition	of Claims						
4a) 5)□ Cla 6)□ Cla 7)⊠ Cla	aim(s) 1-7 is/are pending in the applic Of the above claim(s) is/are waim(s) is/are allowed. aim(s) is/are rejected. aim(s) 1-7 is/are objected to. aim(s) are subject to restriction	ithdrawn from c					
Application	Papers						
10)⊠ The App	e specification is objected to by the Exectation of the exectation of the execution of the	is/are: a)⊠ acc to the drawing(s)	be held in abeyan	ce. See 37 CFR 1.85(a).			
11) <u></u> The	oath or declaration is objected to by	the Examiner. N	lote the attached	Office Action or form PT	O-152.		
Priority unde	er 35 U.S.C. § 119						
a)	nowledgment is made of a claim for full b) Some * c) None of: Certified copies of the priority doci Copies of the certified copies of the application from the International Ithe attached detailed Office action for	uments have be uments have be e priority docum Bureau (PCT Ru	en received. en received in A nents have been ule 17.2(a)).	pplication No received in this National S	Stage		
Attachment(s)							
	References Cited (PTO-892) Draftsperson's Patent Drawing Review (PTO-9	MO)		ummary (PTO-413))/Mail Date			
3) 🔲 Informatio	on Disclosure Statement(s) (PTO-1449 or PTO. (s)/Mail Date	•		formal Patent Application (PTO	-152)		

Application/Control Number: 10/683,838

Art Unit: 2876

DETAILED ACTION

1. This application is in condition for allowance except for the following matters:

Claim Objections

2. Claims 1-3, and 5 are objected to because of the following informalities:

Re claim 1, line 2: Substitute "A upper" with -- An upper--.

Re claim 1, lines 2 and 14: Substitute "includes" with --including--.

Re claim 1, line 6: Substitute "the through holes" with --through holes--.

Re claim 1, lines 7 and 19: Substitute "penetrated" with --penetrate--.

Re claim 1, lines 11 and 23: Substitute "coated" with --coating--.

Re claim 1, lines 12 and 26: Substitute "top memory" with --upper memory--.

Re claim 1, line 26: Substitute "bottom memory" with --lower memory--.

Re claim 2, line 2: Substitute "top memory" with --upper memory--.

Re claim 3: Substitute the current claim with the following: --The stacked small memory card according to claim 1, wherein the metal, which is filled within each of the through holes of the first substrate, is copper--.

Re claim 5, line 2: Substitute "bottom memory" with --lower memory--.

Appropriate correction is required.

3. Prosecution on the merits is closed in accordance with the practice under *Ex* parte Quayle, 1935 C.D. 11, 453 O.G. 213.

A SHORTENED STATUTORY PERIOD FOR RESPONSE TO THIS ACTION IS SET TO EXPIRE **TWO MONTHS** FROM THE DATE OF THIS LETTER.

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Allowable Subject Matter

4. Claims 1-7 would be allowable upon the correction of the objections to claims 1-3, and 5.

5. The following is an examiner's statement of reasons for allowance: The best prior art of record, taken alone or in combination, fails to specifically teach or fairly suggest the stacked small memory card to be set in an electric device, disclosed in the current invention. Although prior art has teachings of stacked small memory cards, the prior art taken of record fails to teach each of the specific and detailed limitations of the claimed stacked card. These features include the stacked small memory card comprising an upper and lower memory card. Both upper and lower memory cards include a substrate, at least one memory chip, a heat sink, and a glue layer. The respective substrates are formed with and upper and lower surface. For the upper memory card, the upper surface of the substrate is formed with a plurality of connected points and golden fingers. For the lower memory card the connected points and golden fingers are formed on the lower surface of the substrate. The golden fingers of both the upper and lower memory cards are electrically connected to the plurality of connected points and a plurality of through holes, which are filled with metal. The through holes penetrate the upper surface to the lower surface. The both the upper and lower memory cards include at least one memory chip. In the case of the upper memory card, the chip is mounted on the upper surface of the substrate. The chip is mounted on the lower surface of the substrate in the lower memory card. The memory chip in both the upper and lower memory cards is connected to the connecting points of the substrate. The

upper memory card's heat sink is mounted on the lower surface of the substrate and is contacted with metal, which is filled within the through holes. The heat sink is mounted on the upper surface in the lower memory card. Each card includes a glue layer coating the memory chip, which is used to arrange in an electric device, so that, the golden fingers of the substrate may be electrically connected to the electric device. The first sink of the upper memory card is mounted on the heat sink of the lower memory card.

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Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

- 6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure: Verma et al (2004/0169285), Ohta et al (2004/0159709), Kim et al (2003/0157748), Kellar et al (2004/0142540), and Nishimura (2004/0152276).
- 7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to *Allyson N. Trail* whose telephone number is (571) 272-2406. The examiner can normally be reached between the hours of 7:30AM to 4:00PM Monday thru Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael G. Lee, can be reached on (571) 272-2398. The fax phone number for this Group is (703) 872-9306.

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Communications via Internet e-mail regarding this application, other than those under 35 U.S.C. 132 or which otherwise require a signature, may be used by the applicant and should be addressed to [allyson.trail@uspto.gov].

All Internet e-mail communications will be made of record in the application file.

PTO employees do not engage in Internet communications where there exists a

possibility that sensitive information could be identified or exchanged unless the record
includes a properly signed express waiver of the confidentiality requirements of 35

U.S.C. 122. This is more clearly set forth in the Interim Internet Usage Policy published
in the Official Gazette of the Patent and Trademark on February 25, 1997 at 1195 OG

89.

Allyson N. Trail Patent Examiner Art Unit 2876 October 17, 2004 JARED J. FUREMAN PRIMARY EXAMINER Page 5